



SDI Review Form 1.6

Journal Name:	British Journal of Applied Science & Technology
Manuscript Number:	2014_BJAST_15214
Title of the Manuscript:	MATERIAL SELECTION FOR HEAT SINKS IN HPC MICROCHIP-BASED CIRCUITRIES
Type of the Article	Original Research Article

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This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound.

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PART 1: Review Comments

	Reviewer's comment	Author's comment <i>(if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)</i>
Compulsory REVISION comments	1. Please add more recent references in the manuscript. 2. Please check and revise references according to the principal of this journal. 3. Please add references of HPC microchips in the background.	More recent references have been added. References have been set according to journal principle References of HPC microchips have been added.
Minor REVISION comments	1. The Equation number used in this manuscript should meet the specifications of this journal. 2. The quality of pictures 6 - 8 need to be modified for clearness.	Equations have been set as prescribed. Effort has been made to modify them. However, unique features of the software must be preserved to convey the true meaning.
Optional/General comments		